

**PATENT APPLICATION**  
**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q93395

Hiroyuki ATAKE

Appln. No.: 10/569,229

Group Art Unit: 1732

Confirmation No.: 7824

Examiner: Unknown

Filed: February 23, 2006

For: APPARATUS AND METHOD FOR MOLDING OF DECORATIVE MOLDED  
ARTICLE

**REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT**

**ATTN:** Office of Initial Patent Examination  
Filing Receipt Correction  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and  
request the following corrections:

**Assignment For Published Patent Application**

Dai Nippon Printing Co., Ltd.

**Title**

~~Device and method for molding of decorative molded articles~~

APPARATUS AND METHOD FOR MOLDING OF DECORATIVE MOLDED

ARTICLE

**Drawings**

~~10-13~~

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT  
US Application No. 10/559,229

Q93395

Verification for the requested corrections is indicated on the Assignment and Application  
Data Sheet filed February 23, 2006.

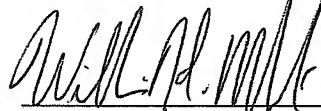
SUGHRUE MION, PLLC  
Telephone: (202) 293-7060  
Facsimile: (202) 293-7860

WASHINGTON OFFICE

**23373**

CUSTOMER NUMBER

Respectfully submitted,



William H. Mandir  
Registration No. 32,156

Date: December 12, 2006



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/569,229	02/23/2006	1732	900	Q93395	10 13 4	4	1

CONFIRMATION NO. 7824

## FILING RECEIPT



\*OC000000020727961\*

23373  
 SUGHRUE MION, PLLC  
 2100 PENNSYLVANIA AVENUE, N.W.  
 SUITE 800  
 WASHINGTON, DC 20037

Date Mailed: 10/06/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Hiroyuki Atake, Tokyo, JAPAN;

ASSIGNMENT FOR PUBLISHED PATENT APPLICATION DAI NIPPON PRINTING CO., LTD.

Power of Attorney: The patent practitioners associated with Customer Number 23373.

## Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/12274 08/26/2004

## Foreign Applications

JAPAN 2003-303279 08/27/2003

JAPAN 2004-193464 06/30/2004

If Required, Foreign Filing License Granted: 10/05/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/569,229**

Projected Publication Date: 01/11/2007

Non-Publication Request: No

Early Publication Request: No

Title

[Device and method for molding of decorative molded articles]  
**APPARATUS AND METHOD FOR MOLDING OF DECORATIVE MOLDED ARTICLE**  
 Preliminary Class

264

## PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

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Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at <http://www.uspto.gov/web/offices/pac/doc/general/index.html>.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, <http://www.stopfakes.gov>. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

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Attorney's Docket No.: \_\_\_\_\_

Assignment of Application

WHEREAS, I (WE) Hiroyuki ATAKE of c/o Dai Nippon Printing Co., Ltd.,  
1-1, Ichigayakaga-cho 1-chome, Shinjuku-ku, Tokyo 1628001 Japan

\_\_\_\_\_, respectively,  
have invented certain new and useful improvements in: \_\_\_\_\_  
Apparatus and method for molding of decorative molded article

for which an application for Letters Patent was executed on February 16, 2006  
(Application No. \_\_\_\_\_, filed \_\_\_\_\_), and

WHEREAS, DAI NIPPON PRINTING CO., LTD.  
(hereinafter referred to as "ASSIGNEE") having a place of business at:  
1-1, Ichigayakaga-cho 1-chome, Shinjuku-ku, Tokyo 1628001 Japan  
is desirous of acquiring the entire right, title and interest in and to said invention  
and in and to any Letters Patent that may be granted therefore in the United  
States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00),  
the receipt whereof is hereby acknowledged, and for other good and valuable  
consideration, I (WE), by these presents do sell, assign and transfer unto said  
ASSIGNEE, the full and exclusive right to the said invention in the United  
States and its territorial possessions and in all foreign countries and the entire  
right, title and interest in and to any and all Letters Patent which may be  
granted therefore in the United States and its territorial possessions and in any  
and all foreign countries and in and to any and all divisions, reissues,  
continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United  
States and its territorial possessions and any official of any and all foreign  
countries to issue any and all of said Letters Patent, when granted, to said  
ASSIGNEE as the assignee of my (our) entire right, title and interest in and to  
the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and  
assigns, to the full end of the term for which said Letters Patent may be granted,  
as fully and entirely as the same would have been held by me (us) had this  
Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its legal representatives and assigns covenant and any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of SUGHRUE MION, PLLC, 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3213 U.S.A. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: February 16, 2006

Hiroynuki Atake

(Signature of inventor)

Hiroynuki ATAKE

Date: \_\_\_\_\_

(Signature of inventor)

Date: \_\_\_\_\_

(Signature of inventor)

## **APPLICATION DATA SHEET**

### **APPLICATION INFORMATION**

Application Type:: Regular  
Subject Matter:: Utility  
Suggested Group Art Unit:: 1732  
Title:: APPARATUS AND METHOD FOR MOLDING OF  
DECORATIVE MOLDED ARTICLE  
Attorney Docket Number:: Q93395  
Request for Early Publication?: No  
Request for Non-Publication?: No  
Total Drawing Sheets:: 13  
Small Entity?: No

### **APPLICANT INFORMATION**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Hiroyuki  
Family Name:: ATAKE  
City of Residence:: Tokyo, Japan  
Country of Residence:: Japan  
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City of mailing address:: Tokyo, Japan  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 1628001



**CORRESPONDENCE INFORMATION**

Correspondence Customer Number::

WASHINGTON OFFICE

**23373**

CUSTOMER NUMBER

Phone number:: (202) 293-7060  
Fax Number: (202) 293-7860  
E-Mail address:: sughrue@sughrue.com

**REPRESENTATIVE INFORMATION**

Representative Customer Number::	WASHINGTON OFFICE <b>23373</b> CUSTOMER NUMBER
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**FOREIGN PRIORITY INFORMATION**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-303279	8/27/2003	Yes
Japan	2004-193464	6/30/2004	Yes

**ASSIGNEE INFORMATION**

Assignee name:: DAI NIPPON PRINTING CO., LTD.  
Street of mailing address:: 1-1 Ichigayakaga-cho 1-chome Shinjuku-ku  
City of mailing address:: Tokyo, Japan  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 1628001